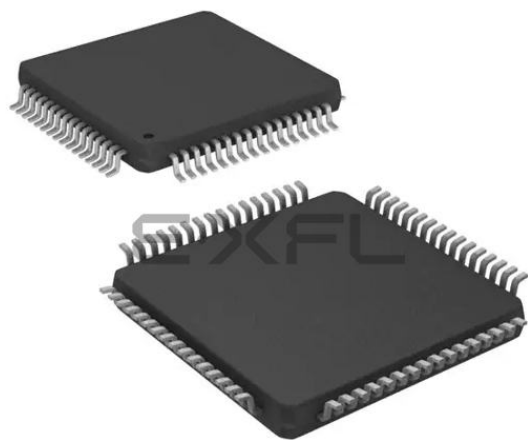




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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I ² C, SPI
Peripherals	LCD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	7KB (4K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	176 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	A/D 5x8b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc924-04-pt

FIGURE 3-2: PIC16C924 BLOCK DIAGRAM

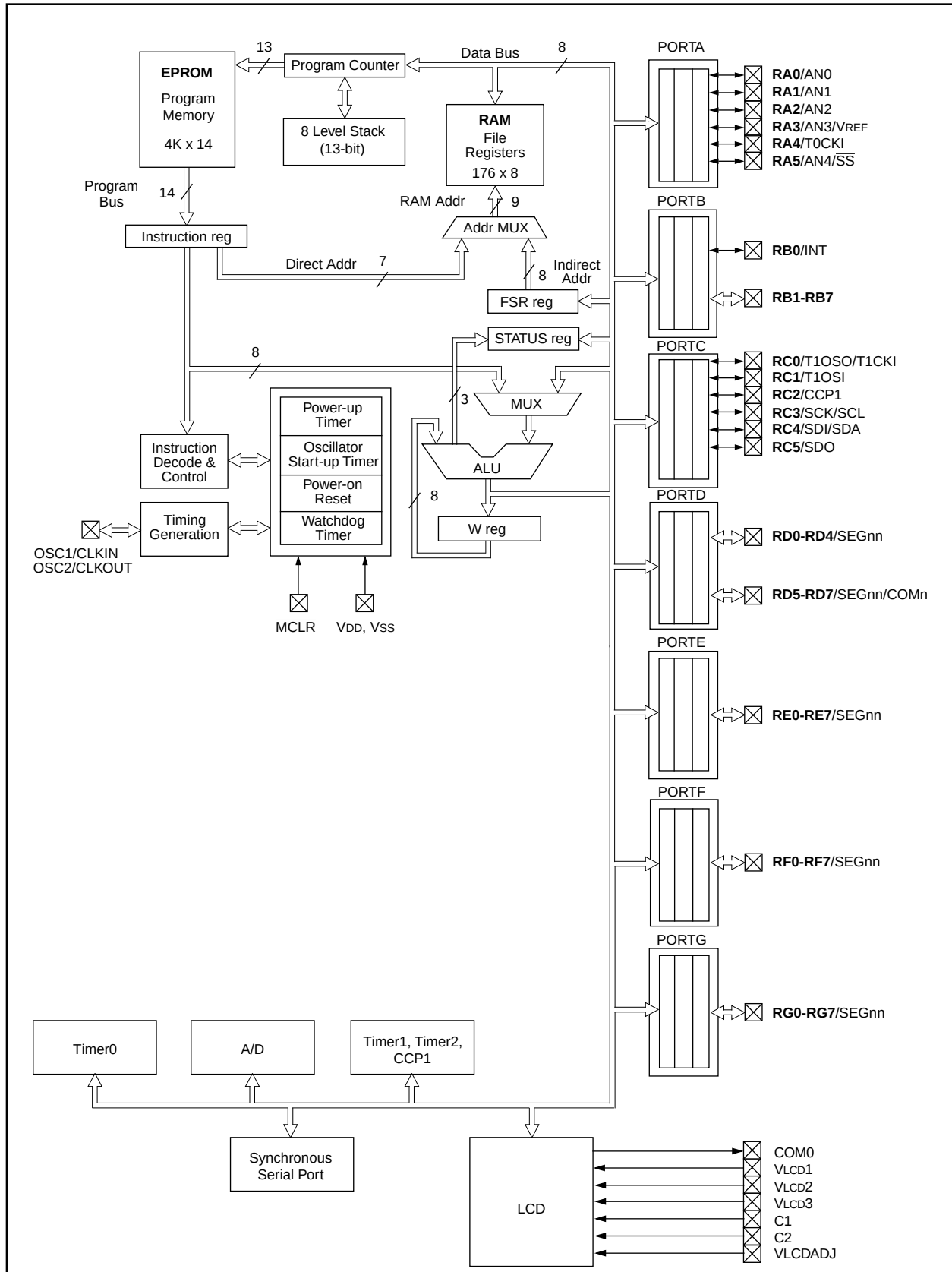


FIGURE 7-3: TIMER0 TIMING: INTERNAL CLOCK/PRESCALE 1:2

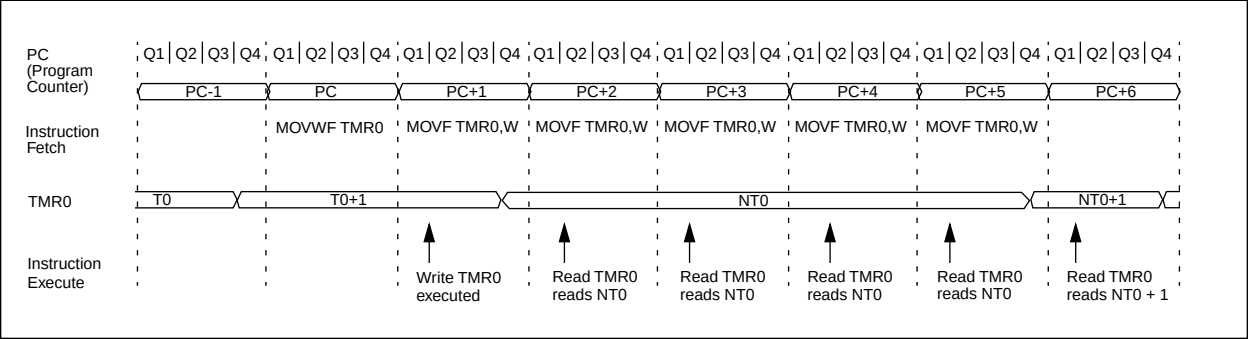
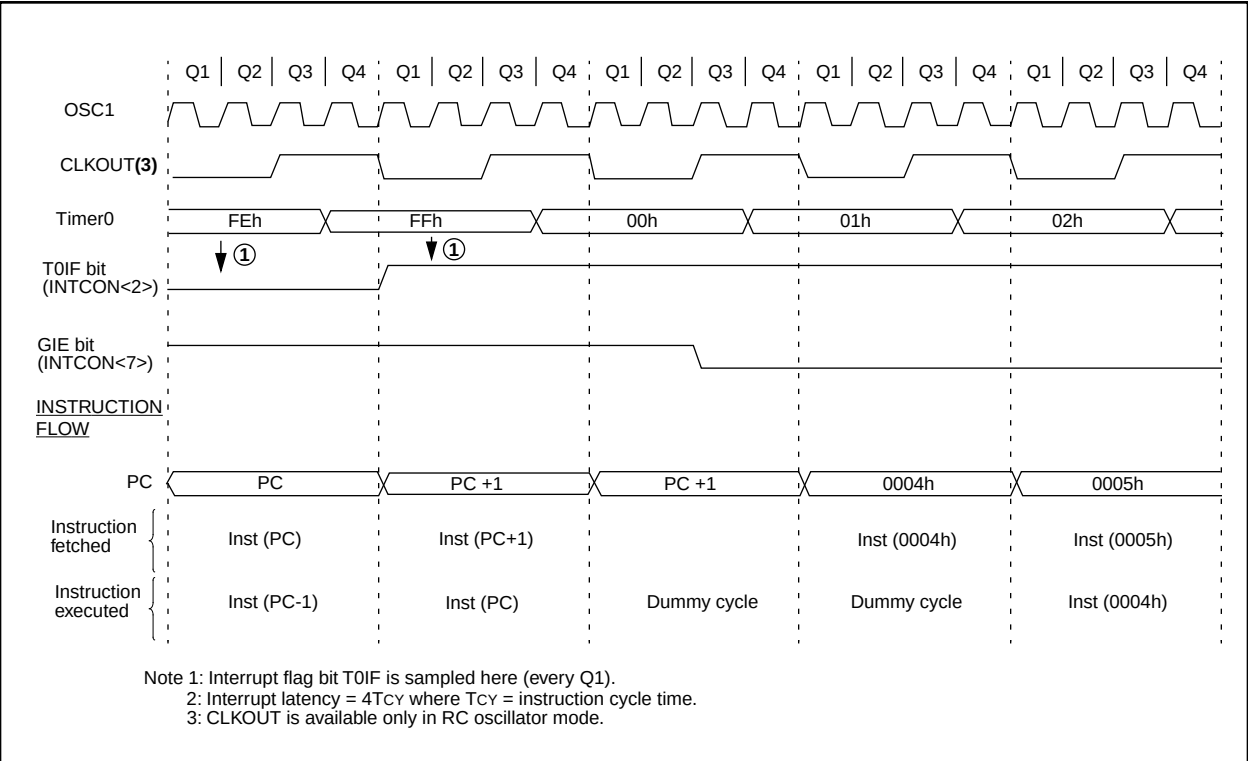


FIGURE 7-4: TIMER0 INTERRUPT TIMING



10.2.1 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

10.2.2 SOFTWARE INTERRUPT MODE

When Generate Software Interrupt is chosen, the CCP1 pin is not affected. Only a CCP interrupt is generated (if enabled).

10.2.3 SPECIAL EVENT TRIGGER

In this mode, an internal hardware trigger is generated which may be used to initiate an action.

The special event trigger output of CCP1 resets the TMR1 register pair and starts an A/D conversion. This allows the CCPR1H:CCPR1L register pair to effectively be a 16-bit programmable period register for Timer1.

Note: The "special event trigger" from the CCP1 module will not set interrupt flag bit TMR1IF (PIR1<0>).

10.3 PWM Mode

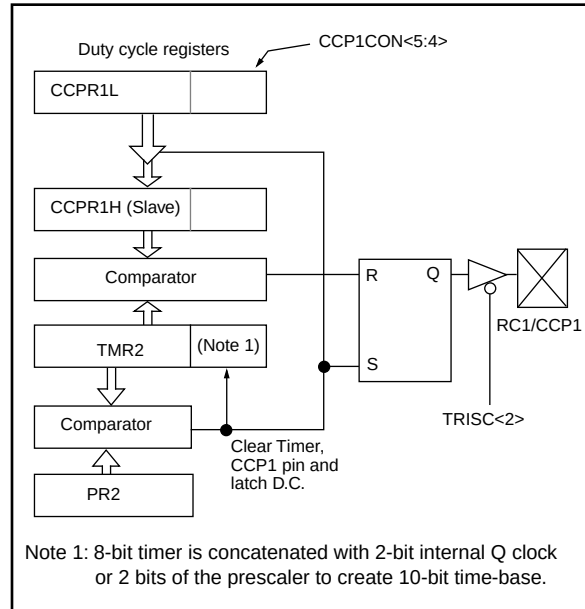
In Pulse Width Modulation (PWM) mode, the CCP1 pin produces up to a 10-bit resolution PWM output. Since the CCP1 pin is multiplexed with the PORTC data latch, the TRISC<2> bit must be cleared to make the CCP1 pin an output.

Note: Clearing the CCP1CON register will force the CCP1 PWM output latch to the default low level. This is not the PORTC I/O data latch.

Figure 10-4 shows a simplified block diagram of the CCP module in PWM mode.

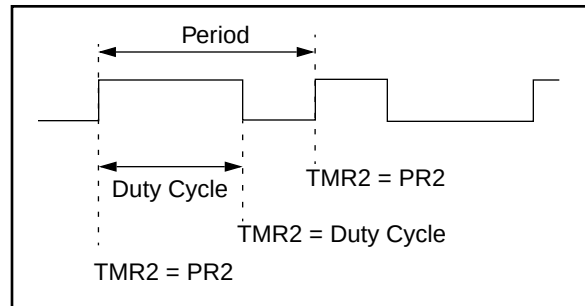
For a step by step procedure on how to set up the CCP module for PWM operation, see Section 10.3.3.

FIGURE 10-4: SIMPLIFIED PWM BLOCK DIAGRAM



A PWM output (Figure 10-5) has a time-base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 10-5: PWM OUTPUT



10.3.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

$$\text{PWM period} = [(PR2) + 1] \cdot 4 \cdot T_{osc} \cdot (\text{TMR2 prescale value})$$

PWM frequency is defined as $1 / [\text{PWM period}]$.

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCP1 pin is set (exception: if PWM duty cycle = 0%, the CCP1 pin will not be set)
- The PWM duty cycle is latched from CCPR1L into CCPR1H

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13.6 Configuring the LCD Module

The following is the sequence of steps to follow to configure the LCD module.

1. Select the frame clock prescale using bits LP3:LP0 (LCDPS<3:0>).
2. Configure the appropriate pins to function as segment drivers using the LCDSE register.
3. Configure the LCD module for the following using the LCDCON register.
 - Multiplex mode and Bias, bits LMUX1:LMUX0
4. Write initial values to pixel data registers, LCDD00 through LCDD15.
5. Clear LCD interrupt flag, LCDIF (PIR1<7>), and if desired, enable the interrupt by setting bit LCDIE (PIE1<7>).
6. Enable the LCD module, by setting bit LCDEN (LCDCON<7>).

TABLE 13-4: SUMMARY OF REGISTERS ASSOCIATED WITH THE LCD MODULE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other Resets
0Bh, 8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	LCDIF	ADIF ⁽¹⁾	—	—	SSPIF	CCP1IF	TMR2IF	TMR1IF	00-- 0000	00-- 0000
8Ch	PIE1	LCDIE	ADIE ⁽¹⁾	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE	00-- 0000	00-- 0000
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYN	TMR1CS	TMR1ON	--00 0000	--uu uuuu
10Dh	LCDSE	SE29	SE27	SE20	SE16	SE12	SE9	SE5	SE0	1111 1111	1111 1111
10Eh	LCDPS	—	—	—	—	LP3	LP2	LP1	LP0	---- 0000	---- 0000
10Fh	LCDCON	LCDEN	SLPEN	—	VGEN	CS1	CS0	LMUX1	LMUX0	00-0 0000	00-0 0000
110h	LCDD00	SEG07 COM0	SEG06 COM0	SEG05 COM0	SEG04 COM0	SEG03 COM0	SEG02 COM0	SEG01 COM0	SEG00 COM0	xxxx xxxx	uuuu uuuu
111h	LCDD01	SEG15 COM0	SEG14 COM0	SEG13 COM0	SEG12 COM0	SEG11 COM0	SEG10 COM0	SEG09 COM0	SEG08 COM0	xxxx xxxx	uuuu uuuu
112h	LCDD02	SEG23 COM0	SEG22 COM0	SEG21 COM0	SEG20 COM0	SEG19 COM0	SEG18 COM0	SEG17 COM0	SEG16 COM0	xxxx xxxx	uuuu uuuu
113h	LCDD03	SEG31 COM0	SEG30 COM0	SEG29 COM0	SEG28 COM0	SEG27 COM0	SEG26 COM0	SEG25 COM0	SEG24 COM0	xxxx xxxx	uuuu uuuu
114h	LCDD04	SEG07 COM1	SEG06 COM1	SEG05 COM1	SEG04 COM1	SEG03 COM1	SEG02 COM1	SEG01 COM1	SEG00 COM1	xxxx xxxx	uuuu uuuu
115h	LCDD05	SEG15 COM1	SEG14 COM1	SEG13 COM1	SEG12 COM1	SEG11 COM1	SEG10 COM1	SEG09 COM1	SEG08 COM1	xxxx xxxx	uuuu uuuu
116h	LCDD06	SEG23 COM1	SEG22 COM1	SEG21 COM1	SEG20 COM1	SEG19 COM1	SEG18 COM1	SEG17 COM1	SEG16 COM1	xxxx xxxx	uuuu uuuu
117h	LCDD07	SEG31 COM1 ⁽²⁾	SEG30 COM1	SEG29 COM1	SEG28 COM1	SEG27 COM1	SEG26 COM1	SEG25 COM1	SEG24 COM1	xxxx xxxx	uuuu uuuu
118h	LCDD08	SEG07 COM2	SEG06 COM2	SEG05 COM2	SEG04 COM2	SEG03 COM2	SEG02 COM2	SEG01 COM2	SEG00 COM2	xxxx xxxx	uuuu uuuu
119h	LCDD09	SEG15 COM2	SEG14 COM2	SEG13 COM2	SEG12 COM2	SEG11 COM2	SEG10 COM2	SEG09 COM2	SEG08 COM2	xxxx xxxx	uuuu uuuu
11Ah	LCDD10	SEG23 COM2	SEG22 COM2	SEG21 COM2	SEG20 COM2	SEG19 COM2	SEG18 COM2	SEG17 COM2	SEG16 COM2	xxxx xxxx	uuuu uuuu
11Bh	LCDD11	SEG31 COM2 ⁽²⁾	SEG30 COM2 ⁽²⁾	SEG29 COM2	SEG28 COM2	SEG27 COM2	SEG26 COM2	SEG25 COM2	SEG24 COM2	xxxx xxxx	uuuu uuuu
11Ch	LCDD12	SEG07 COM3	SEG06 COM3	SEG05 COM3	SEG04 COM3	SEG03 COM3	SEG02 COM3	SEG01 COM3	SEG00 COM3	xxxx xxxx	uuuu uuuu
11Dh	LCDD13	SEG15 COM3	SEG14 COM3	SEG13 COM3	SEG12 COM3	SEG11 COM3	SEG10 COM3	SEG09 COM3	SEG08 COM3	xxxx xxxx	uuuu uuuu
11Eh	LCDD14	SEG23 COM3	SEG22 COM3	SEG21 COM3	SEG20 COM3	SEG19 COM3	SEG18 COM3	SEG17 COM3	SEG16 COM3	xxxx xxxx	uuuu uuuu
11Fh	LCDD15	SEG31 COM3 ⁽²⁾	SEG30 COM3 ⁽²⁾	SEG29 COM3 ⁽²⁾	SEG28 COM3	SEG27 COM3	SEG26 COM3	SEG25 COM3	SEG24 COM3	xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by the LCD Module.

Note 1: These bits are reserved on the PIC16C923, always maintain these bits clear.

2: These pixels do not display, but can be used as general purpose RAM.

FIGURE 14-8: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO V_{DD}): CASE 1

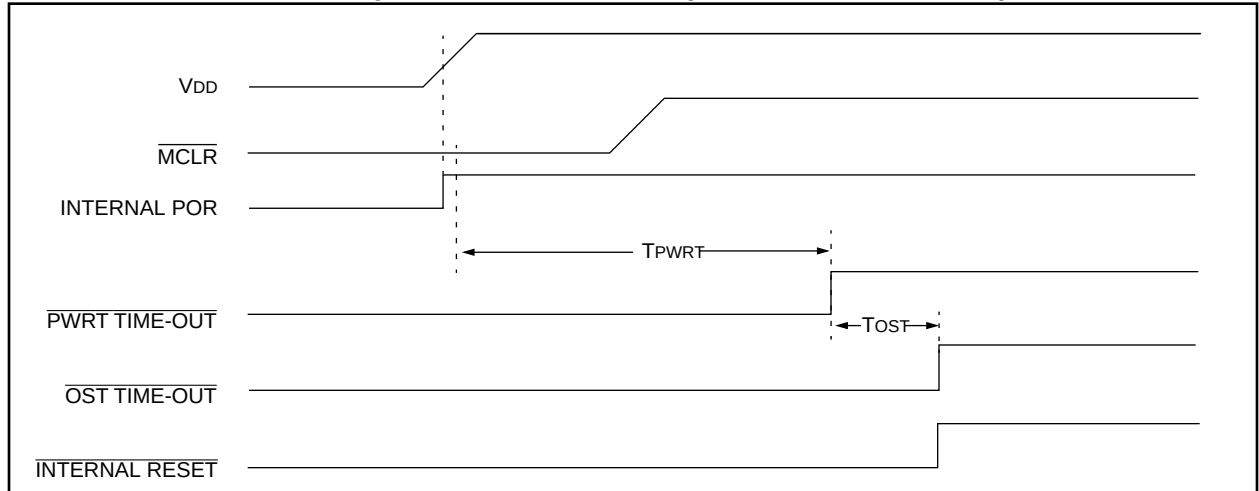


FIGURE 14-9: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO V_{DD}): CASE 2

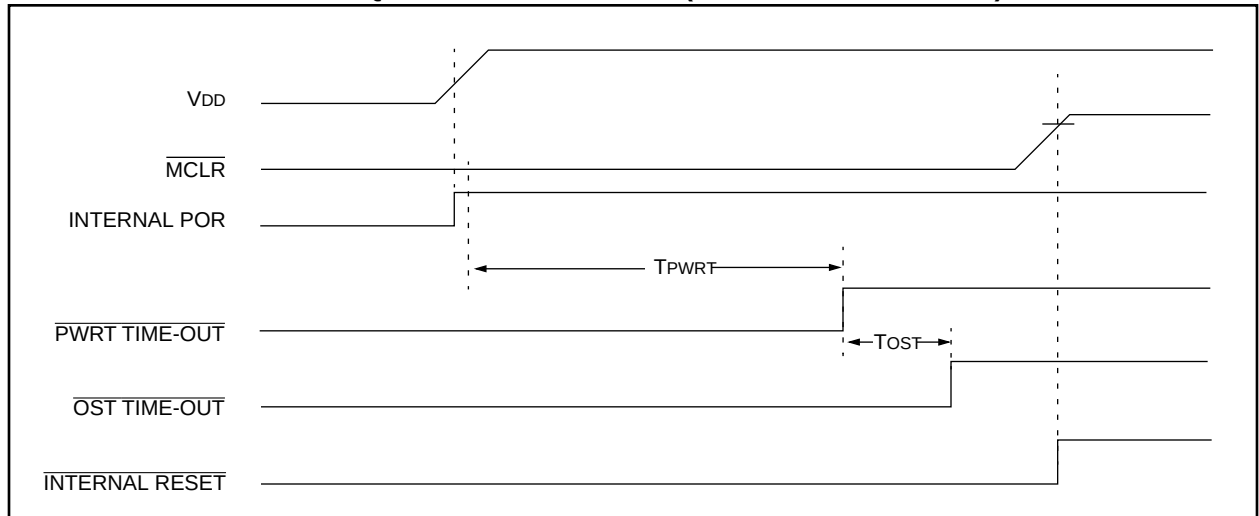
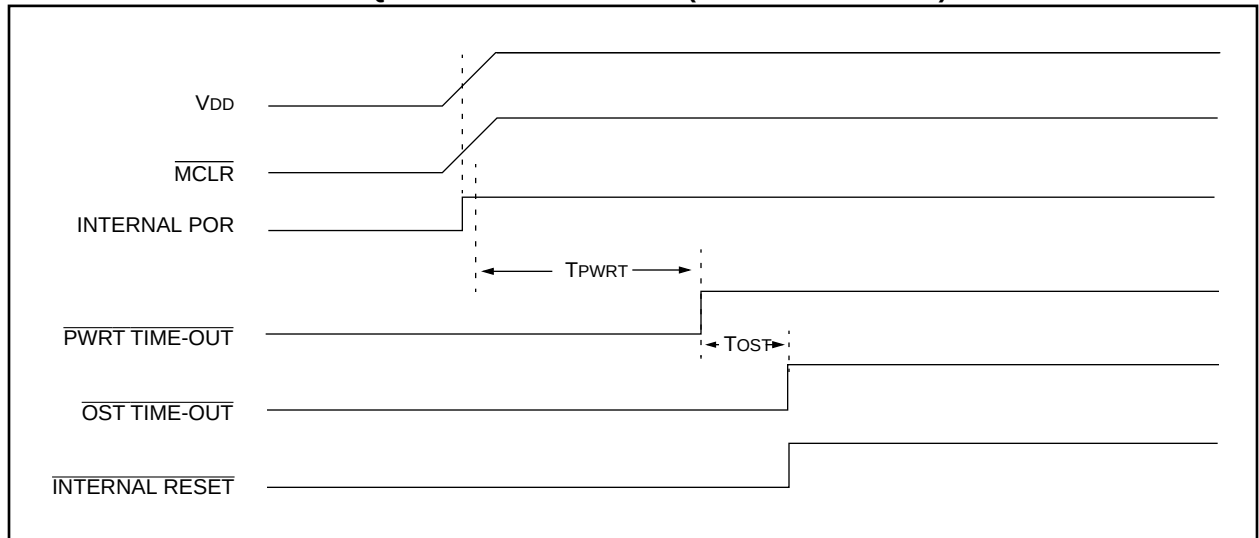


FIGURE 14-10: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ TIED TO V_{DD})



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FIGURE 14-14: INTERRUPT LOGIC

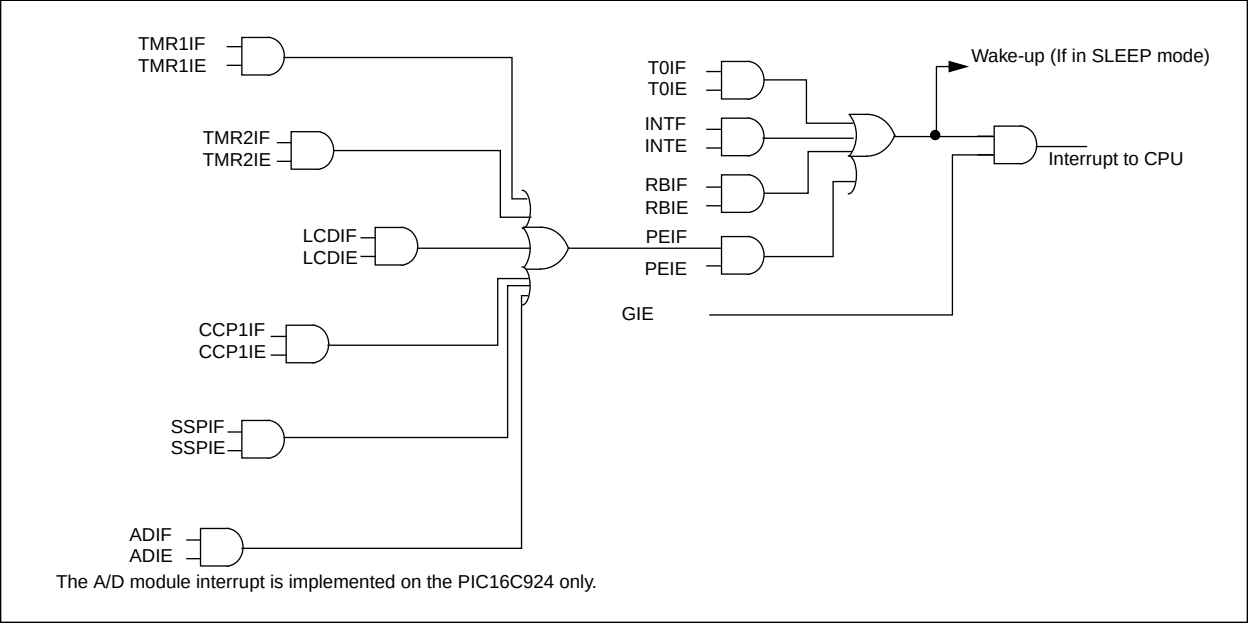
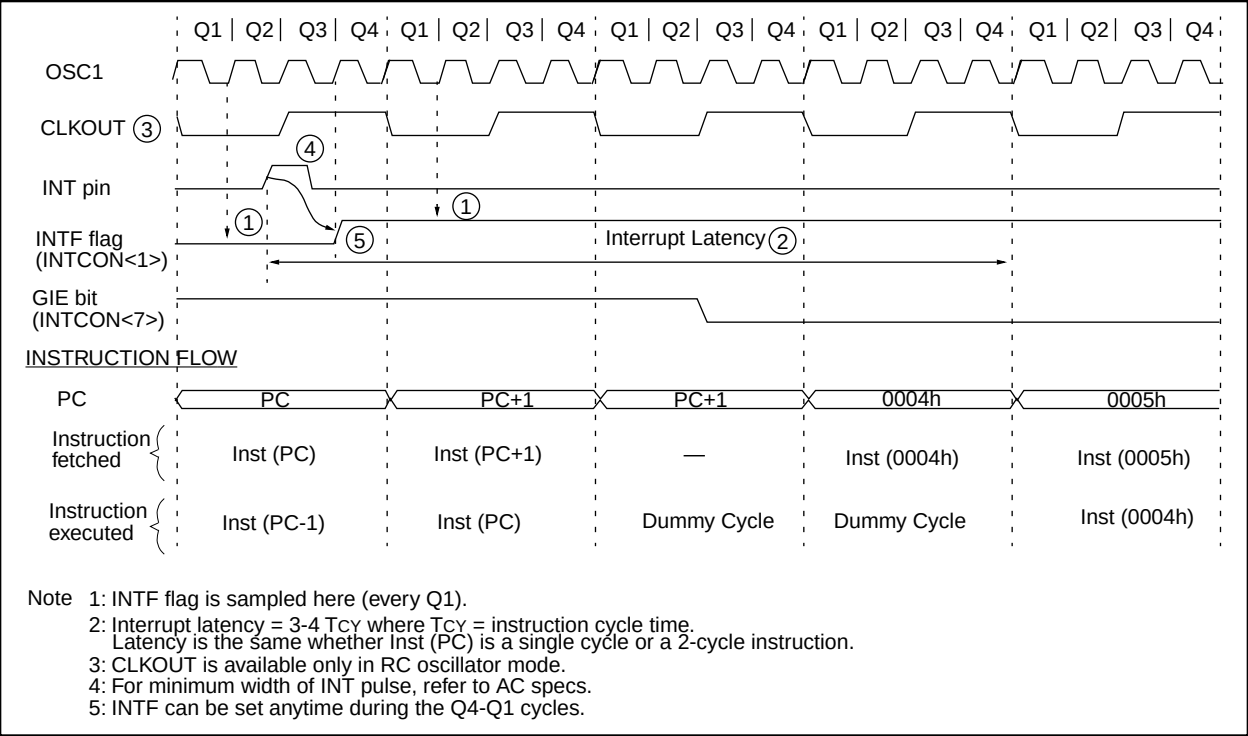


FIGURE 14-15: INT PIN INTERRUPT TIMING



NOP		No Operation			
Syntax:	[<i>label</i>] NOP				
Operands:	None				
Operation:	No operation				
Status Affected:	None				
Encoding:	00	0000	0xx0	0000	
Description:	No operation.				
Words:	1				
Cycles:	1				
Q Cycle Activity:	Q1	Q2	Q3	Q4	
	Decode	No-Operation	No-Operation	No-Operation	
Example	NOP				

RETFIE		Return from Interrupt						
Syntax:	[<i>label</i>] RETFIE							
Operands:	None							
Operation:	TOS → PC, 1 → GIE							
Status Affected:	None							
Encoding:	<table><tr><td>00</td><td>0000</td><td>0000</td><td>1001</td></tr></table>				00	0000	0000	1001
00	0000	0000	1001					
Description:	Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two cycle instruction.							
Words:	1							
Cycles:	2							
Q Cycle Activity:	Q1	Q2	Q3	Q4				
1st Cycle	Decode	No-Operation	Set the GIE bit	Pop from the Stack				
2nd Cycle	No-Operation	No-Operation	No-Operation	No-Operation				

Example RETFIE

After Interrupt

PC = TOS

GIE = 1

OPTION	Load Option Register			
Syntax:	[<i>label</i>] OPTION			
Operands:	None			
Operation:	(W) → OPTION			
Status Affected:	None			
Encoding:	00	0000	0110	0010
Description:	The contents of the W register are loaded in the OPTION register. This instruction is supported for code compatibility with PIC16C5X products. Since OPTION is a readable/writable register, the user can directly address it.			
Words:	1			
Cycles:	1			
Example	To maintain upward compatibility with future PIC16CXX products, do not use this instruction.			

16.0 DEVELOPMENT SUPPORT

16.1 Development Tools

The PICmicro™ microcontrollers are supported with a full range of hardware and software development tools:

- PICMASTER/PICMASTER CE Real-Time In-Circuit Emulator
- ICEPIC Low-Cost PIC16C5X and PIC16CXXX In-Circuit Emulator
- PRO MATE® II Universal Programmer
- PICSTART® Plus Entry-Level Prototype Programmer
- PICDEM-1 Low-Cost Demonstration Board
- PICDEM-2 Low-Cost Demonstration Board
- PICDEM-3 Low-Cost Demonstration Board
- MPASM Assembler
- MPLAB™ SIM Software Simulator
- MPLAB-C (C Compiler)
- Fuzzy Logic Development System (*fuzzyTECH*®-MP)

16.2 PICMASTER: High Performance Universal In-Circuit Emulator with MPLAB IDE

The PICMASTER Universal In-Circuit Emulator is intended to provide the product development engineer with a complete microcontroller design tool set for all microcontrollers in the PIC12CXXX, PIC14C000, PIC16C5X, PIC16CXXX and PIC17CXX families. PICMASTER is supplied with the MPLAB™ Integrated Development Environment (IDE), which allows editing, “make” and download, and source debugging from a single environment.

Interchangeable target probes allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the PICMASTER allows expansion to support all new Microchip microcontrollers.

The PICMASTER Emulator System has been designed as a real-time emulation system with advanced features that are generally found on more expensive development tools. The PC compatible 386 (and higher) machine platform and Microsoft Windows® 3.x environment were chosen to best make these features available to you, the end user.

A CE compliant version of PICMASTER is available for European Union (EU) countries.

16.3 ICEPIC: Low-Cost PIC16CXXX In-Circuit Emulator

ICEPIC is a low-cost in-circuit emulator solution for the Microchip PIC16C5X and PIC16CXXX families of 8-bit OTP microcontrollers.

ICEPIC is designed to operate on PC-compatible machines ranging from 286-AT® through Pentium™ based machines under Windows 3.x environment. ICEPIC features real time, non-intrusive emulation.

16.4 PRO MATE II: Universal Programmer

The PRO MATE II Universal Programmer is a full-featured programmer capable of operating in stand-alone mode as well as PC-hosted mode.

The PRO MATE II has programmable VDD and VPP supplies which allows it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for displaying error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In stand-alone mode the PRO MATE II can read, verify or program PIC12CXXX, PIC14C000, PIC16C5X, PIC16CXXX and PIC17CXX devices. It can also set configuration and code-protect bits in this mode.

16.5 PICSTART Plus Entry Level Development System

The PICSTART programmer is an easy-to-use, low-cost prototype programmer. It connects to the PC via one of the COM (RS-232) ports. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. PICSTART Plus is not recommended for production programming.

PICSTART Plus supports all PIC12CXXX, PIC14C000, PIC16C5X, PIC16CXXX and PIC17CXX devices with up to 40 pins. Larger pin count devices such as the PIC16C923 and PIC16C924 may be supported with an adapter socket.

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16.6 PICDEM-1 Low-Cost PICmicro Demonstration Board

The PICDEM-1 is a simple board which demonstrates the capabilities of several of Microchip's microcontrollers. The microcontrollers supported are: PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The users can program the sample microcontrollers provided with the PICDEM-1 board, on a PRO MATE II or PICSTART-Plus programmer, and easily test firmware. The user can also connect the PICDEM-1 board to the PICMASTER emulator and download the firmware to the emulator for testing. Additional prototype area is available for the user to build some additional hardware and connect it to the microcontroller socket(s). Some of the features include an RS-232 interface, a potentiometer for simulated analog input, push-button switches and eight LEDs connected to PORTB.

16.7 PICDEM-2 Low-Cost PIC16CXX Demonstration Board

The PICDEM-2 is a simple demonstration board that supports the PIC16C62, PIC16C64, PIC16C65, PIC16C73 and PIC16C74 microcontrollers. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM-2 board, on a PRO MATE II programmer or PICSTART-Plus, and easily test firmware. The PICMASTER emulator may also be used with the PICDEM-2 board to test firmware. Additional prototype area has been provided to the user for adding additional hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push-button switches, a potentiometer for simulated analog input, a Serial EEPROM to demonstrate usage of the I²C bus and separate headers for connection to an LCD module and a keypad.

16.8 PICDEM-3 Low-Cost PIC16CXXX Demonstration Board

The PICDEM-3 is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with a LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM-3 board, on a PRO MATE II programmer or PICSTART Plus with an adapter socket, and easily test firmware. The PICMASTER emulator may also be used with the PICDEM-3 board to test firmware. Additional prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features include

an RS-232 interface, push-button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM-3 board is an LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM-3 provides an additional RS-232 interface and Windows 3.1 software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals.

16.9 MPLAB™ Integrated Development Environment Software

The MPLAB IDE Software brings an ease of software development previously unseen in the 8-bit microcontroller market. MPLAB is a windows based application which contains:

- A full featured editor
- Three operating modes
 - editor
 - emulator
 - simulator
- A project manager
- Customizable tool bar and key mapping
- A status bar with project information
- Extensive on-line help

MPLAB allows you to:

- Edit your source files (either assembly or 'C')
- One touch assemble (or compile) and download to PICmicro tools (automatically updates all project information)
- Debug using:
 - source files
 - absolute listing file
- Transfer data dynamically via DDE (soon to be replaced by OLE)
- Run up to four emulators on the same PC

The ability to use MPLAB with Microchip's simulator allows a consistent platform and the ability to easily switch from the low cost simulator to the full featured emulator with minimal retraining due to development tools.

16.10 Assembler (MPASM)

The MPASM Universal Macro Assembler is a PC-hosted symbolic assembler. It supports all microcontroller series including the PIC12C5XX, PIC14000, PIC16C5X, PIC16CXXX, and PIC17CXX families.

MPASM offers full featured Macro capabilities, conditional assembly, and several source and listing formats. It generates various object code formats to support Microchip's development tools as well as third party programmers.

MPASM allows full symbolic debugging from PICMASTER, Microchip's Universal Emulator System.

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17.3 DC Characteristics:

PIC16C923/924-04 (Commercial, Industrial)
PIC16C923/924-08 (Commercial, Industrial)
PIC16LC923/924-04 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial Operating voltage V_{DD} range as described in DC spec							
Param No.	Characteristic	Sym	Min	Typ †	Max	Units	Conditions
D030 D031 D032 D033	Input Low Voltage I/O ports with TTL buffer	V_{IL}	V_{SS}	-	$0.15V_{DD}$	V	For entire V_{DD} range $4.5V \leq V_{DD} \leq 5.5V$ Note1
			V_{SS}	-	0.8V	V	
	with Schmitt Trigger buffer		V_{SS}	-	$0.2V_{DD}$	V	
	$\overline{\text{MCLR}}$, OSC1 (in RC mode)		V_{SS}	-	$0.2V_{DD}$	V	
	OSC1 (in XT, HS and LP)		V_{SS}	-	$0.3V_{DD}$	V	
D040 D040A D041 D042 D042A D043	Input High Voltage I/O ports with TTL buffer	V_{IH}	-	-	-	-	For entire V_{DD} range Note1
			2.0	-	V_{DD}	V	
			$0.25V_{DD} + 0.8V$	-	V_{DD}	V	
	with Schmitt Trigger buffer		0.8V	-	V_{DD}	V	
	$\overline{\text{MCLR}}$		0.8V	-	V_{DD}	V	
	OSC1 (XT, HS and LP)		$0.7V_{DD}$	-	V_{DD}	V	
	OSC1 (in RC mode)		$0.9V_{DD}$	-	V_{DD}	V	
D070	PORTB weak pull-up current	IPURB	50	250	400	μA	$V_{DD} = 5V$, $V_{PIN} = V_{SS}$
D060 D061 D063	Input Leakage Current (Notes 2, 3)	I_{IL}	-	-	± 1.0	μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$, Pin at hi-Z $V_{SS} \leq V_{PIN} \leq V_{DD}$ $V_{SS} \leq V_{PIN} \leq V_{DD}$, XT, HS and LP osc configuration
	I/O ports		-	-	± 5	μA	
	$\overline{\text{MCLR}}$, RA4/T0CKI		-	-	± 5	μA	
	OSC1		-	-	± 5	μA	
D080 D083	Output Low Voltage I/O ports	V_{OL}	-	-	0.6	V	$I_{OL} = 4.0 \text{ mA}$, $V_{DD} = 4.5V$
	OSC2/CLKOUT (RC osc mode)		-	-	0.6	V	$I_{OL} = 1.6 \text{ mA}$, $V_{DD} = 4.5V$
D090 D092	Output High Voltage I/O ports (Note 3)	V_{OH}	$V_{DD} - 0.7$	-	-	V	$I_{OH} = -3.0 \text{ mA}$, $V_{DD} = 4.5V$
	OSC2/CLKOUT (RC osc mode)		$V_{DD} - 0.7$	-	-	V	$I_{OH} = -1.3 \text{ mA}$, $V_{DD} = 4.5V$
D100* D101* D102* D150*	Capacitive Loading Specs on Output Pins OSC2 pin	C_{OSC2}	-	-	15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.
	All I/O pins and OSC2 (in RC)	C_{IO}	-	-	50	pF	
	SCL, SDA in I ² C mode	CB	-	-	400	pF	
	Open -Drain High Voltage	V_{DD}	-	-	14	V	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C9XX be driven with external clock in RC mode.

2: The leakage current on the $\overline{\text{MCLR}}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

FIGURE 17-4: CLKOUT AND I/O TIMING

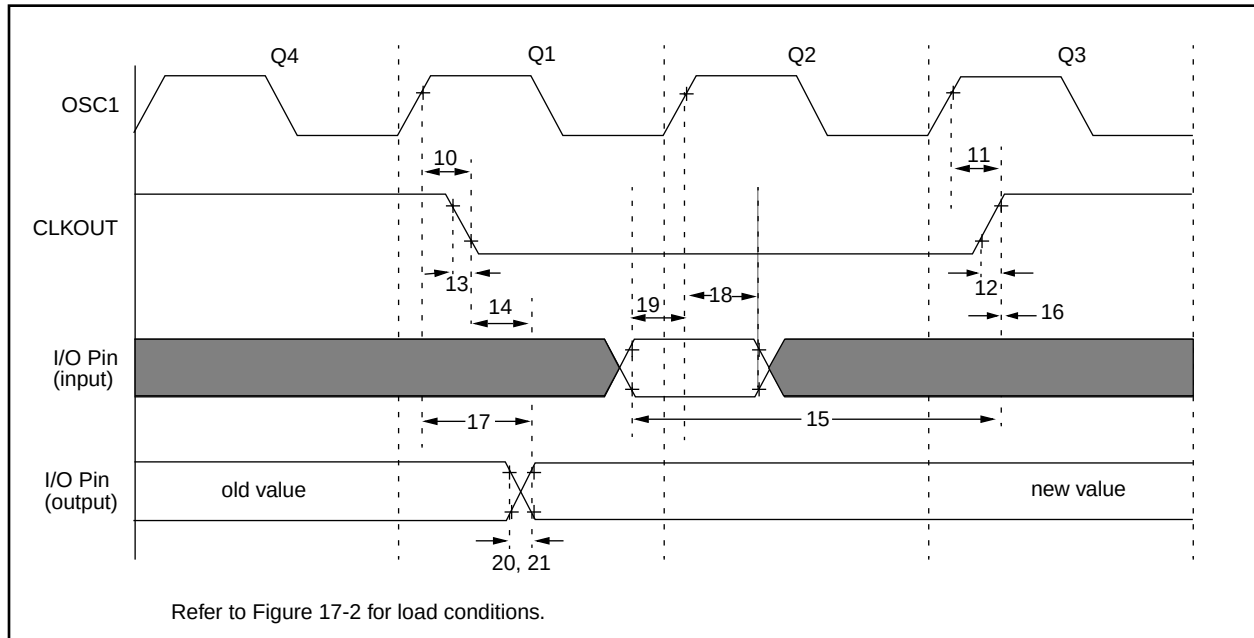


TABLE 17-5: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓	—	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑	—	75	200	ns	Note 1
12*	TckR	CLKOUT rise time	—	35	100	ns	Note 1
13*	TckF	CLKOUT fall time	—	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid	—	—	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑	Tosc + 200	—	—	ns	Note 1
16*	TckH2ioI	Port in hold after CLKOUT ↑	0	—	—	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid	—	50	150	ns	
18*	TosH2ioI	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	PIC16C923/924	100	—	—	ns
			PIC16LC923/924	200	—	—	ns
19*	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	0	—	—	ns	
20*	TioR	Port output rise time	PIC16C923/924	—	10	40	ns
			PIC16LC923/924	—	—	80	ns
21*	TioF	Port output fall time	PIC16C923/924	—	10	40	ns
			PIC16LC923/924	—	—	80	ns
22††	Tinp	INT pin high or low time	Tcy	—	—	ns	
23††	Trbp	RB7:RB4 change INT high or low time	Tcy	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

†† These parameters are asynchronous events not related to any internal clock edges.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x TOSC.

FIGURE 17-8: SPI MASTER MODE TIMING (CKE = 0)

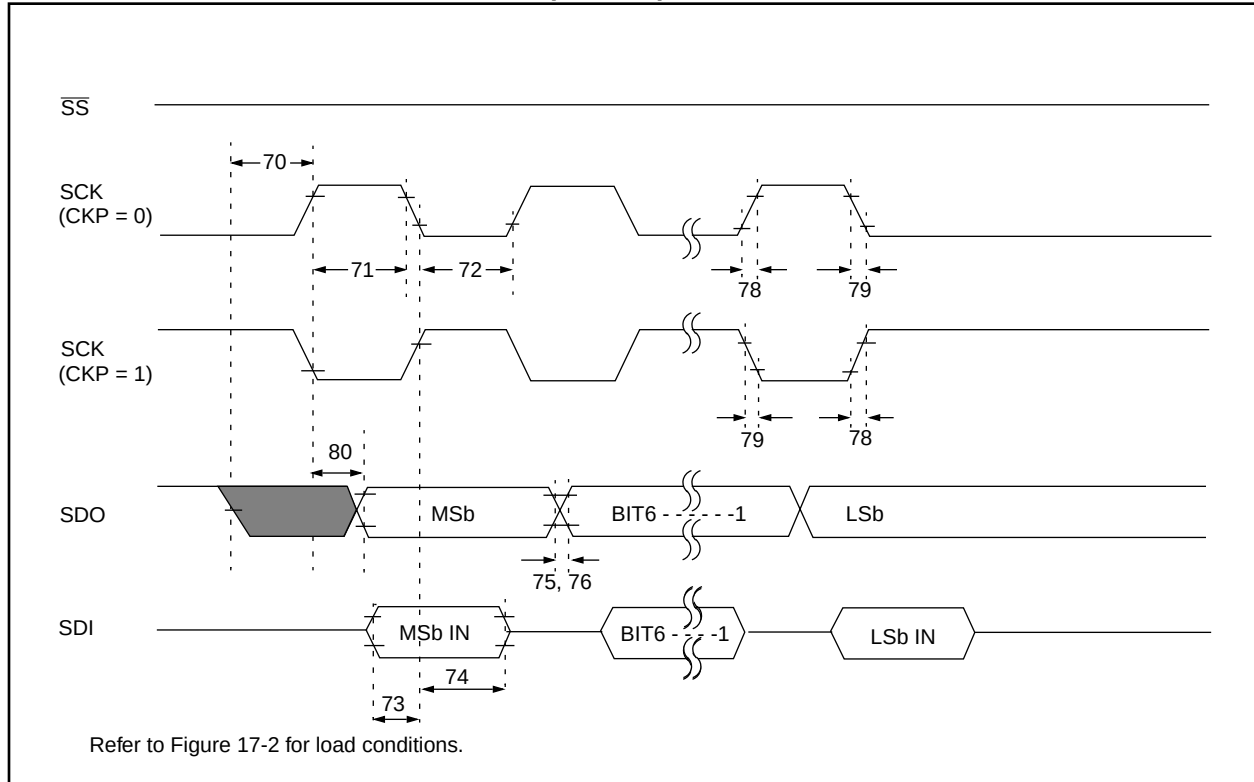


FIGURE 17-9: SPI MASTER MODE TIMING (CKE = 1)

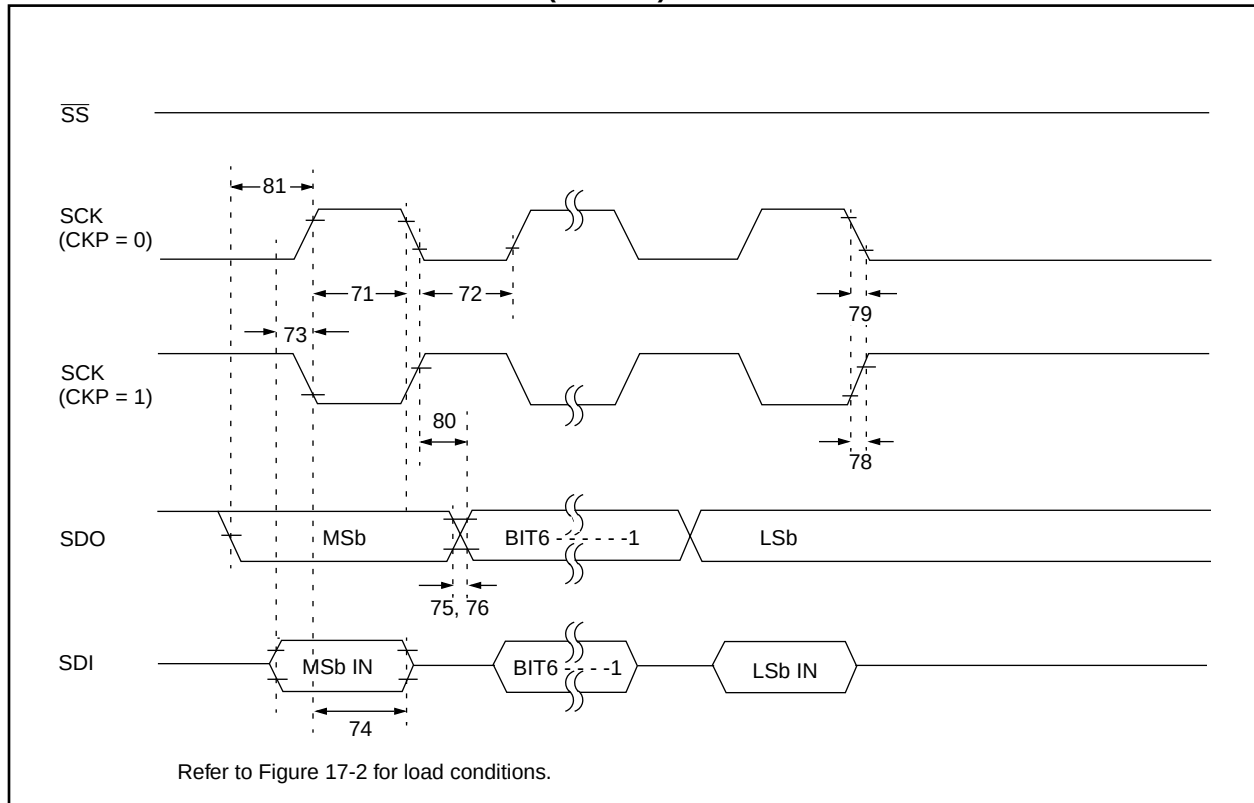


TABLE 17-9: SPI MODE REQUIREMENTS

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	$\overline{SS}\downarrow$ to SCK $\downarrow$ or SCK $\uparrow$ input	T _{CY}	—	—	ns	
71*	TscH	SCK input high time (slave mode)	Continuous	1.25T _{CY} + 30	—	—	ns
71A*		Single Byte	40	—	—	ns	
72*	TscL	SCK input low time (slave mode)	Continuous	1.25T _{CY} + 30	—	—	ns
72A*		Single Byte	40				
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	50	—	—	ns	
74*	Tsch2diL, TscL2diL	Hold time of SDI data input to SCK edge	50	—	—	ns	
75*	TdoR	SDO data output rise time	—	10	25	ns	
76*	TdoF	SDO data output fall time	—	10	25	ns	
77*	TssH2doZ	$\overline{SS}\uparrow$ to SDO output hi-impedance	10	—	50	ns	
78*	TscR	SCK output rise time (master mode)	—	10	25	ns	
79*	TscF	SCK output fall time (master mode)	—	10	25	ns	
80*	Tsch2doV, TscL2doV	SDO data output valid after SCK edge	—	—	50	ns	
81*	TdoV2scH, TdoV2scL	SDO data output setup to SCK edge	T _{CY}	—	—	ns	
82*	TssL2doV	SDO data output valid after $\overline{SS}\downarrow$ edge	—	—	50	ns	
83*	Tsch2ssH, TscL2ssH	$\overline{SS}\uparrow$ after SCK edge	1.5T _{CY} + 40	—	—	ns	
84*	Tb2b	Delay between consecutive bytes	1.5T _{CY} + 40	—	—	ns	

* Characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 17-14:A/D CONVERSION TIMING

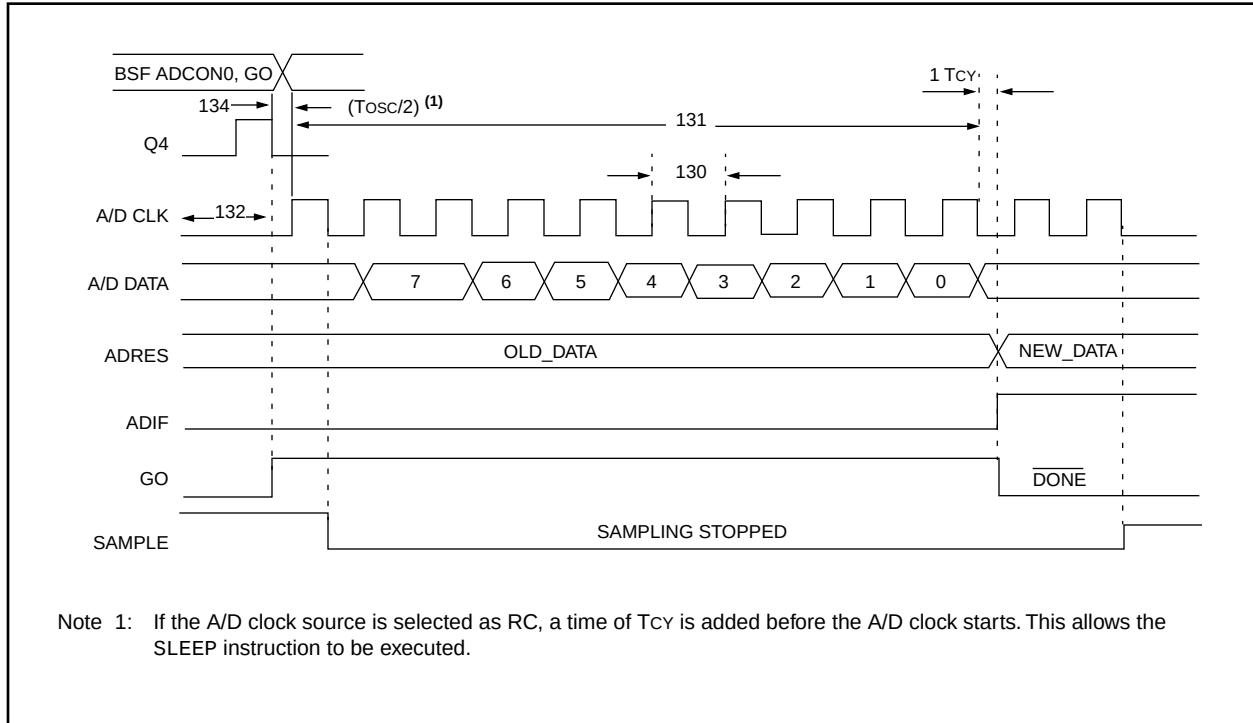


TABLE 17-13:A/D CONVERSION REQUIREMENTS

Param No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
130	TAD	A/D clock period	PIC16C924	1.6	—	—	μs	TOSC based, VREF ≥ 3.0V
			PIC16LC924	2.0	—	—	μs	TOSC based, VREF full range
			PIC16C924	2.0	4.0	6.0	μs	A/D RC Mode
			PIC16LC924	3.0	6.0	9.0	μs	A/D RC Mode
131	Tcnv	Conversion time (not including S/H time) (Note 1)		—	9.5	—	TAD	
132	TACQ	Acquisition time		Note 2	20	—	μs	The minimum time is the amplifier settling time. This may be used if the "new" input voltage has not changed by more than 1 LSb (i.e., 20.0 mV @ 5.12V) from the last sampled voltage (as stated on CHOLD).
				5*	—	—	μs	
134	TGo	Q4 to A/D clock start		—	Tosc/2 §	—	—	If the A/D clock source is selected as RC, a time of T_{cy} is added before the A/D clock starts. This allows the SLEEP instruction to be executed.
135	Tswc	Switching from convert → sample time		1.5 §	—	—	TAD	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

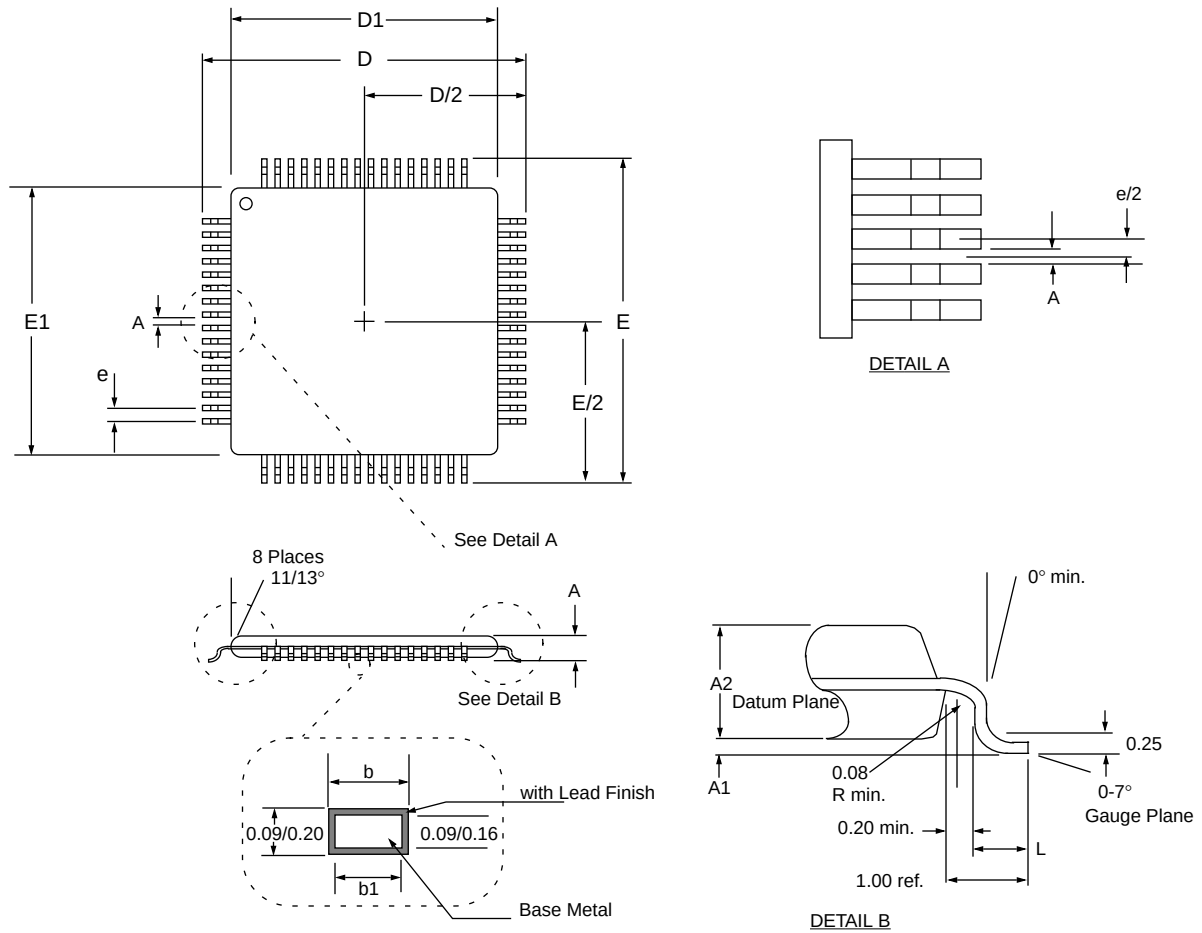
§ This specification ensured by design.

Note 1: ADRES register may be read on the following T_{cy} cycle.

Note 2: See Section 12.1 for min conditions.

19.0 PACKAGING INFORMATION

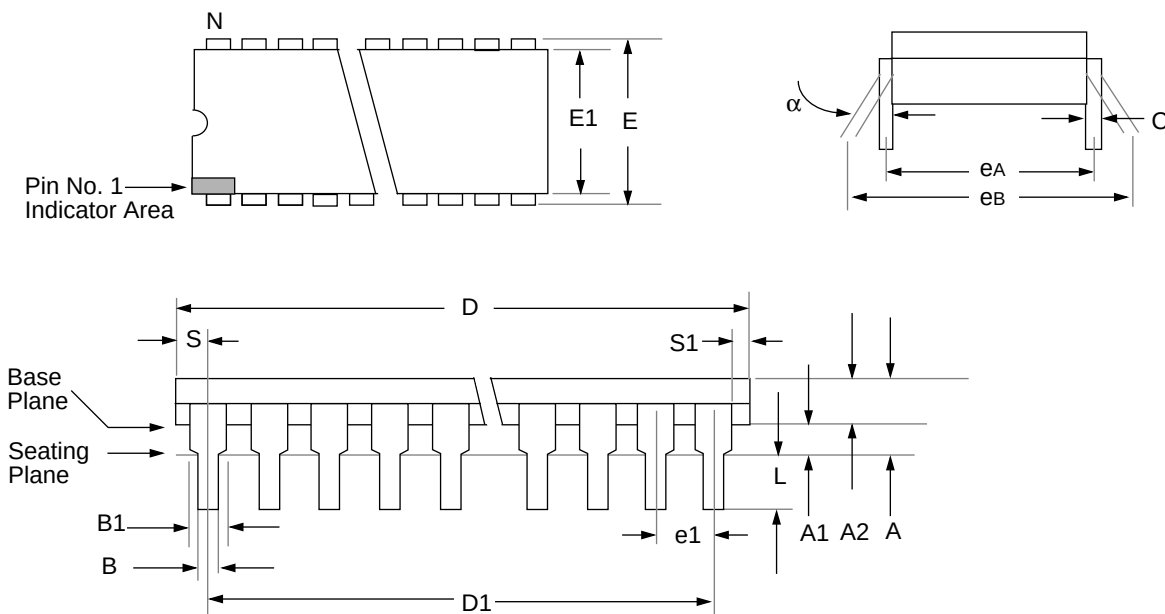
19.1 64-Lead Plastic Surface Mount (TQFP 10x10x1 mm Body 1.0/0.10 mm Lead Form))



Package Group: Plastic TQFP						
Symbol	Millimeters			Inches		
	Min	Nominal	Max	Min	Nominal	Max
α	0°	-	7°	0°	-	7°
A	-	-	1.20	-	-	0.047
A1	0.05	0.10	0.15	0.002	0.004	0.006
A2	0.95	1.00	1.05	0.037	0.039	0.041
b	0.17	0.22	0.27	0.007	0.009	0.011
b1	0.17	0.20	0.23	0.007	0.008	0.009
D	-	12.00	-	-	0.472	-
D1	-	10.00	-	-	0.394	-
E	-	12.00	-	-	0.472	-
E1	-	10.00	-	-	0.394	-
e	-	0.50	-	-	0.020	-
L	0.45	0.60	0.75	0.018	0.024	0.030
N	64	64	64	64	64	64

PIC16C9XX

19.2 64-Lead Plastic Dual In-line (750 mil)



Package Group: Plastic Dual In-Line (PLA)						
Symbol	Millimeters			Inches		
	Min	Max	Notes	Min	Max	Notes
α	0°	15°		0°	15°	
A	—	5.08		—	0.200	
A1	0.51	—		0.020	—	
A2	3.38	4.27		0.133	0.168	
B	0.38	0.56		0.015	0.022	
B1	.076	1.27	Typical	0.030	0.050	Typical
C	0.20	0.30	Typical	0.008	0.012	Typical
D	57.40	57.91		2.260	2.280	
D1	55.12	55.12	Reference	2.170	2.170	Reference
E	19.05	19.69		0.750	0.775	
E1	16.76	17.27		0.660	0.680	
e1	1.73	1.83	Typical	0.068	0.072	Typical
eA	19.05	19.05	Reference	0.750	0.750	Reference
eB	19.05	21.08		0.750	0.830	
L	3.05	3.43		0.120	0.135	
N	64	64		64	64	
S	1.19	—		0.047	—	
S1	0.686	—		0.027	—	

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